

MAXIM**8-Pin μ P Supervisory Circuits
with $\pm 1.5\%$ Reset Accuracy****MAX801L/M/N, MAX808L/M/N****General Description**

The MAX801/MAX808 microprocessor (μ P) supervisory circuits monitor and control the activities of +5V μ Ps by providing backup-battery switchover, low-line indication, and μ P reset. Additional features include a watchdog for the MAX801 and CMOS RAM write protection for the MAX808.

The MAX801/MAX808 offer a choice of reset-threshold voltage (denoted by suffix letter): 4.675V (L), 4.575V (N), and 4.425V (M). These devices are available in 8-pin DIP and SO packages.

Applications

Computers
Controllers
Intelligent Instruments
Critical μ P Power Monitoring
Portable/Battery-Powered Equipment
Embedded Systems

Features

- ♦ **Precision Voltage Monitoring, $\pm 1.5\%$ Reset Accuracy**
- ♦ **200ms Power-OK/Reset Time Delay**
- ♦ **RESET Output (MAX808)**
RESET and RESET Outputs (MAX801)
- ♦ **Watchdog Timer (MAX801)**
- ♦ **On-Board Gating of Chip-Enable Signals (MAX808):**
Memory Write-Cycle Completion
3ns CE Gate Propagation Delay
- ♦ **1 μ A Standby Current**
- ♦ **Power Switching:**
250mA in V_{CC} Mode
20mA in Battery-Backup Mode
- ♦ **MaxCap™/SuperCap™ Compatible**
- ♦ **RESET Guaranteed Valid to V_{CC} = 1V**
- ♦ **Low-Line Threshold 52mV Above Reset Threshold**

MaxCap is a trademark of The Carborundum Corp.
SuperCap is a trademark of Baknor Industries.

Ordering Information

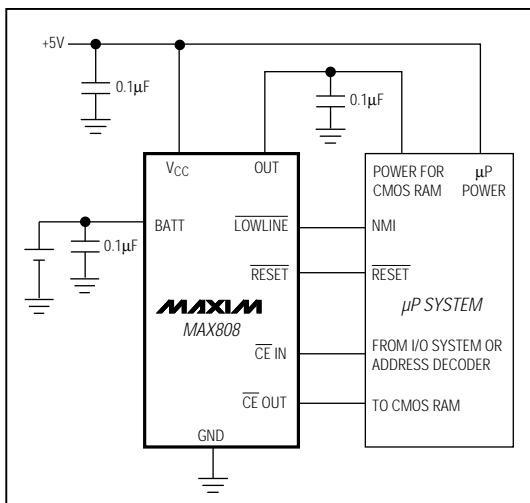
PART*	TEMP. RANGE	PIN-PACKAGE
MAX801_CPA	0°C to +70°C	8 Plastic DIP
MAX801_CSA	0°C to +70°C	8 SO
MAX801_EPA	-40°C to +85°C	8 Plastic DIP
MAX801_ESA	-40°C to +85°C	8 SO
MAX801_MJA	-55°C to +125°C	8 CERDIP**
MAX808_CPA	0°C to +70°C	8 Plastic DIP
MAX808_CSA	0°C to +70°C	8 SO
MAX808_EPA	-40°C to +85°C	8 Plastic DIP
MAX808_ESA	-40°C to +85°C	8 SO
MAX808_MJA	-55°C to +125°C	8 CERDIP**

* These parts offer a choice of reset threshold voltage. From the table below, select the suffix corresponding to the desired threshold and insert it into the blank to complete the part number.

**Contact factory for availability and processing to MIL-STD-883.

SUFFIX	RESET THRESHOLD (V)		
	MIN	TYP	MAX
L	4.60	4.675	4.75
N	4.50	4.575	4.65
M	4.35	4.425	4.50

Pin Configurations appear at end of data sheet.

Typical Operating Circuit

Maxim Integrated Products 1

For free samples & the latest literature: <http://www.maxim-ic.com>, or phone 1-800-998-8800

8-Pin μ P Supervisory Circuits with $\pm 1.5\%$ Reset Accuracy

ABSOLUTE MAXIMUM RATINGS

Input Voltage (with respect to GND)	
V _{CC}	-0.3V to +6V
V _{BATT}	-0.3V to +6V
All Other Pins	-0.3V to (V _{OUT} + 0.3V)
Input Current	
V _{CC} Peak	1.0A
V _{CC} Continuous	500mA
I _{BATT} Peak	250mA
I _{BATT} Continuous	50mA
GND	50mA
All Other Inputs	50mA
Output Current	
OUT Peak	1.0A

OUT Continuous	500mA
All Other Outputs	50mA
Continuous Power Dissipation (TA = +70°C)	
Plastic DIP (derate 9.09mW/°C above +70°C)	727mW
SO (derate 5.88mW/°C above +70°C)	471mW
CERDIP (derate 8.00mW/°C above +70°C)	640mW
Operating Temperature Ranges	
MAX801_C_A/MAX808_C_A	0°C to +70°C
MAX801_E_A/MAX808_E_A	-40°C to +85°C
MAX801_MJA/MAX808_MJA	-55°C to +125°C
Storage Temperature Range	-65°C to +160°C
Lead Temperature (soldering, 10sec)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{CC} = 4.6V to 5.5V for the MAX80_L, V_{CC} = 4.5V to 5.5V for the MAX80_N, V_{CC} = 4.35V to 5.5V for the MAX80_M; V_{BATT} = 2.8V; TA = T_{MIN} to T_{MAX}. Typical values are at V_{CC} = 5V and TA = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Operating Voltage Range V _{CC} , BATT (Note 1)				0	X	5.5	V
V _{OUT} in Normal Operating Mode	V _{CC} = 4.5V	I _{OUT} = 25mA		V _{CC} - 0.02			V
		I _{OUT} = 250mA, MAX80_C/E		V _{CC} - 0.38	V _{CC} - 0.25		
		I _{OUT} = 250mA, MAX80_M		V _{CC} - 0.45			
		V _{CC} = 3V, V _{BATT} = 2.8V, I _{OUT} = 100mA		V _{CC} - 0.25	V _{CC} - 0.12		
V _{CC} to OUT On-Resistance	V _{CC} = 4.5V, I _{OUT} = 250mA	MAX80_C/E		1.0	1.5		Ω
		MAX80_M			1.8		
		V _{CC} = 3V, I _{OUT} = 100mA			1.2	2.5	
V _{OUT} in Battery-Backup Mode	V _{CC} = 0V	V _{BATT} = 4.5V, I _{OUT} = 20mA		V _{BATT} - 0.16			V
		V _{BATT} = 2.8V, I _{OUT} = 10mA		V _{BATT} - 0.25	V _{BATT} - 0.12		
		V _{BATT} = 2.0V, I _{OUT} = 5mA		V _{BATT} - 0.20	V _{BATT} - 0.08		
BATT to OUT On-Resistance	V _{CC} = 0V	V _{BATT} = 4.5V, I _{OUT} = 20mA			8		Ω
		V _{BATT} = 2.8V, I _{OUT} = 10mA			12	25	
		V _{BATT} = 2.0V, I _{OUT} = 5mA			16	40	
Supply Current in Normal Operating Mode (excludes I _{OUT})	MAX801				68	110	μ A
					48	90	
Supply Current in Battery- Backup Mode (excludes I _{OUT}) (Note 2)	V _{CC} = 0V, V _{BATT} = 2.8V	TA = +25°C			0.4	1	μ A
		TA = T _{MIN} to T _{MAX}	MAX80_C/E			5	
			MAX80_M			50	
BATT Standby Current (Note 3)	V _{BATT} + 0.2V \leq V _{CC}	TA = +25°C		-0.1	0.1		μ A
		TA = T _{MIN} to T _{MAX}		-1.0	1.0		
Battery-Switchover Threshold	V _{BATT} = 2.8V	Power-up		V _{BATT} + 0.05			V
		Power-down		V _{BATT}			
Battery-Switchover Hysteresis					50		mV

8-Pin μ P Supervisory Circuits with $\pm 1.5\%$ Reset Accuracy

ELECTRICAL CHARACTERISTICS (continued)

($V_{CC} = 4.6V$ to $5.5V$ for the MAX80_L, $V_{CC} = 4.5V$ to $5.5V$ for the MAX80_N, $V_{CC} = 4.35V$ to $5.5V$ for the MAX80_M; $V_{BATT} = 2.8V$; $T_A = T_{MIN}$ to T_{MAX} . Typical values are at $V_{CC} = 5V$ and $T_A = +25^\circ C$, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
RESET AND LOW-LINE							
Reset Threshold	V _{RST}	V _{CC} rising and falling	MAX80_L	4.600	4.675	4.750	
			MAX80_N	4.500	4.575	4.650	
			MAX80_M	4.350	4.425	4.500	
Reset-Threshold Hysteresis				13		mV	
LOWLINE to RESET Threshold Voltage	V _{LR}	V _{CC} falling		30	52	70	mV
LOWLINE Threshold, V _{CC} Rising	V _{LL}	MAX80_L		4.73	4.81		V
		MAX80_N		4.63	4.71		
		MAX80_M		4.48	4.56		
V _{CC} to RESET Delay	t _{RD}	V _{CC} falling at 1mV/ μ s		17		μ s	
V _{CC} to LOWLINE Delay	t _{LL}	V _{CC} falling at 1mV/ μ s		17		μ s	
RESET Active Timeout Period	t _{RP}	V _{CC} rising	140	200	280	ms	
RESET Output Voltage		ISINK = 50 μ A, V _{CC} = 1.0V, MAX80_C V _{BATT} = 0V, V _{CC} falling			0.3		V
		V _{CC} = 1.2V, MAX80_E/M			0.3		
		ISINK = 3.2mA, V _{CC} = 4.25V		0.1	0.4		
		ISOURCE = 0.1mA	V _{CC} - 1.5	V _{CC} - 0.1			
RESET Output Short-Circuit Current	I _{SC}	Output sink current, V _{CC} = 4.25V		40			mA
		Output source current		1.6			
RESET Output Voltage (MAX801)		ISINK = 3.2mA			0.4		V
		ISOURCE = 5mA, V _{CC} = 4.25V	V _{CC} - 1.5				
RESET Output Short-Circuit Current (MAX801)	I _{SC}	Output sink current		55			mA
		Output source current, V _{CC} = 4.25V		15			
LOWLINE Output Voltage		ISINK = 3.2mA, V _{CC} = 4.25V			0.4		V
		ISOURCE = 5mA, V _{CC} = 4.25V	V _{CC} - 1.5				
LOWLINE Output Short-Circuit Current	I _{SC}	Output sink current, V _{CC} = 4.25V		40			mA
		Output source current		20			
WATCHDOG TIMER (MAX801)							
Watchdog Timeout Period	t _{WD}		1.12	1.6	2.24	sec	
Minimum Watchdog Input Pulse Width		V _I L = 0.8V, V _I H = 0.75V \times V _{CC}	100			ns	
WDI Threshold Voltage (Note 4)	V _I H		0.75 \times V _{CC}				V
	V _I L			0.8			
WDI Input Current		RESET deasserted, WDI = 0V	-50	-10			μ A
		RESET deasserted, WDI = V _{CC}		16	50		

MAX801L/M/N, MAX808L/M/N

8-Pin μ P Supervisory Circuits with $\pm 1.5\%$ Reset Accuracy

ELECTRICAL CHARACTERISTICS (continued)

($V_{CC} = 4.6V$ to $5.5V$ for the MAX801_L, $V_{CC} = 4.5V$ to $5.5V$ for the MAX801_N, $V_{CC} = 4.35V$ to $5.5V$ for the MAX801_M; $V_{BATT} = 2.8V$; $T_A = T_{MIN}$ to T_{MAX} . Typical values are at $V_{CC} = 5V$ and $T_A = +25^\circ C$, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
CHIP-ENABLE GATING (MAX808)						
\overline{CE} IN Leakage Current		$V_{CC} = 4.25V$		± 0.00002	± 1	μA
\overline{CE} IN to \overline{CE} OUT Resistance (Note 5)		Enabled mode, $V_{CC} = V_{RST(max)}$		75	150	Ω
\overline{CE} OUT Short-Circuit Current (RESET Active)		$V_{CC} = 4.25V$, \overline{CE} OUT = 0V		15		mA
\overline{CE} IN to \overline{CE} OUT Propagation Delay (Note 6)		$V_{CC} = 5V$, $C_{LOAD} = 50pF$, 50 Ω source-impedance driver		3	8	ns
\overline{CE} OUT Output Voltage High (RESET Active)		$V_{CC} = 4.25V$, $I_{OUT} = 2mA$	3.5			V
		$V_{CC} = 0V$, $I_{OUT} = 10\mu A$	$V_{BATT} - 0.1$	V_{BATT}		
RESET to \overline{CE} OUT Delay (Note 7)		V_{CC} falling, \overline{CE} IN = 0V		18		μs

Note 1: Either V_{CC} or V_{BATT} can go to 0V if the other is greater than 2V.

Note 2: The supply current drawn by the MAX801 from the battery (excluding I_{OUT}) typically goes to 15 μA when $(V_{BATT} - 0.1V) < V_{CC} < V_{BATT}$. In most applications, this is a brief period as V_{CC} falls through this region (see *Typical Operating Characteristics*).

Note 3: "+" = battery-discharging current, "-" = battery-charging current.

Note 4: WDI is internally connected to a voltage divider between V_{CC} and GND. If unconnected, WDI is typically driven to 1.8V, disabling the watchdog function.

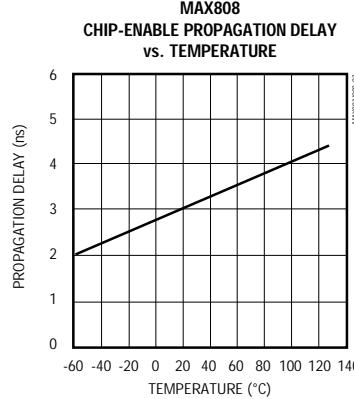
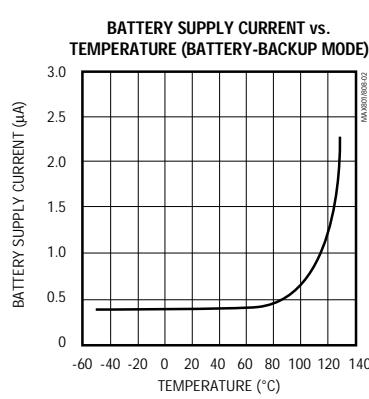
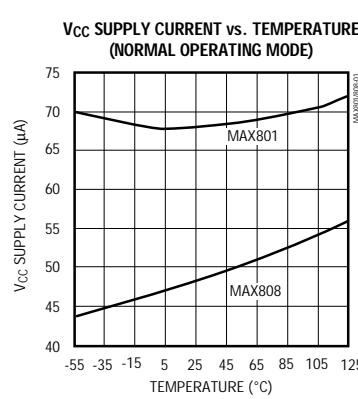
Note 5: The chip-enable resistance is tested with $V_{\overline{CE}} \text{ IN} = V_{CC} / 2$ and $I_{\overline{CE}} \text{ IN} = 1mA$.

Note 6: The chip-enable propagation delay is measured from the 50% point at \overline{CE} IN to the 50% point at \overline{CE} OUT.

Note 7: If \overline{CE} IN goes high, \overline{CE} OUT goes high immediately and stays high until reset is deasserted and \overline{CE} IN is low.

Typical Operating Characteristics

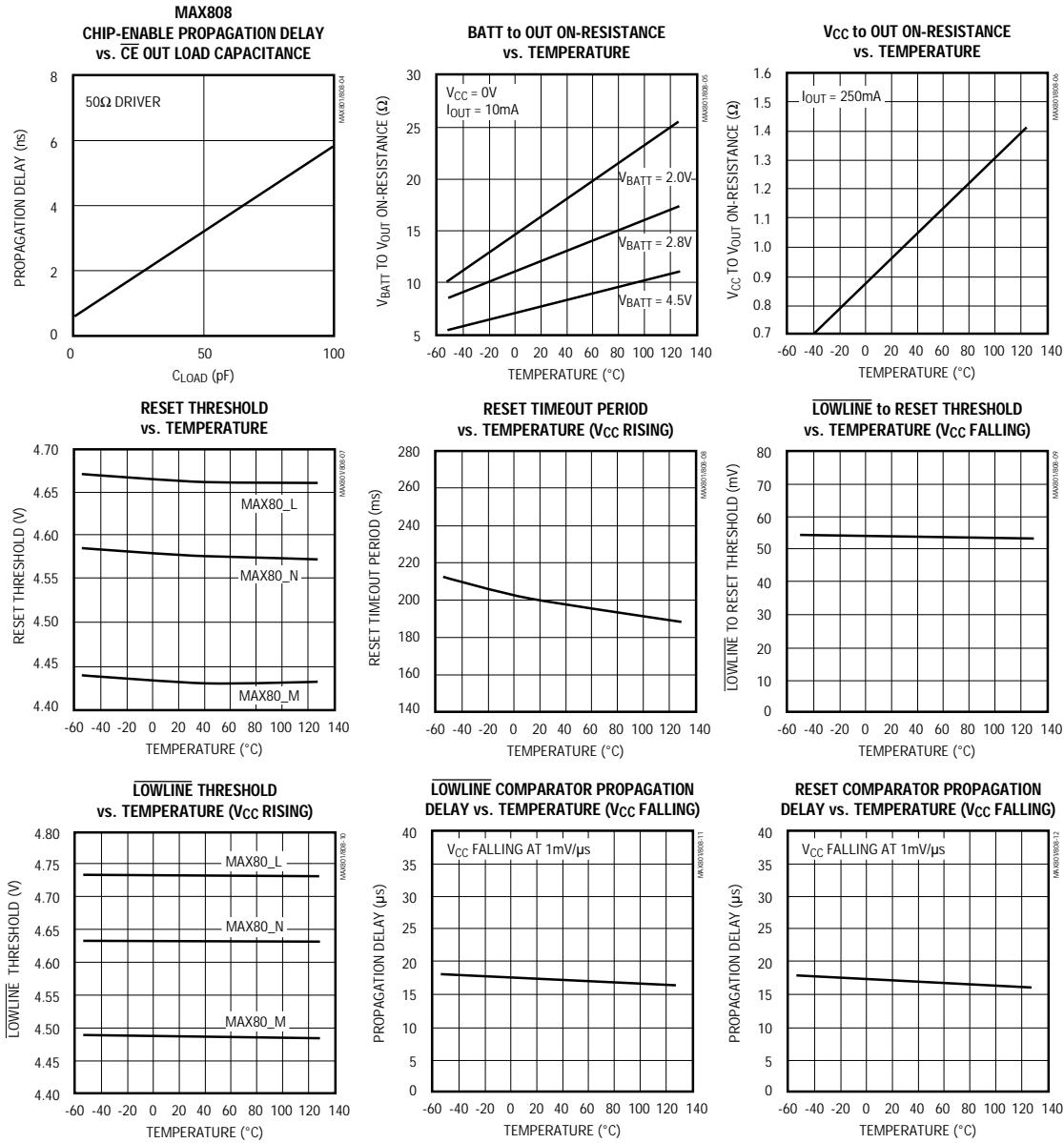
($V_{CC} = 5V$, $V_{BATT} = 2.8V$, no load, $T_A = +25^\circ C$, unless otherwise noted.)



8-Pin μ P Supervisory Circuits with $\pm 1.5\%$ Reset Accuracy

Typical Operating Characteristics (continued)

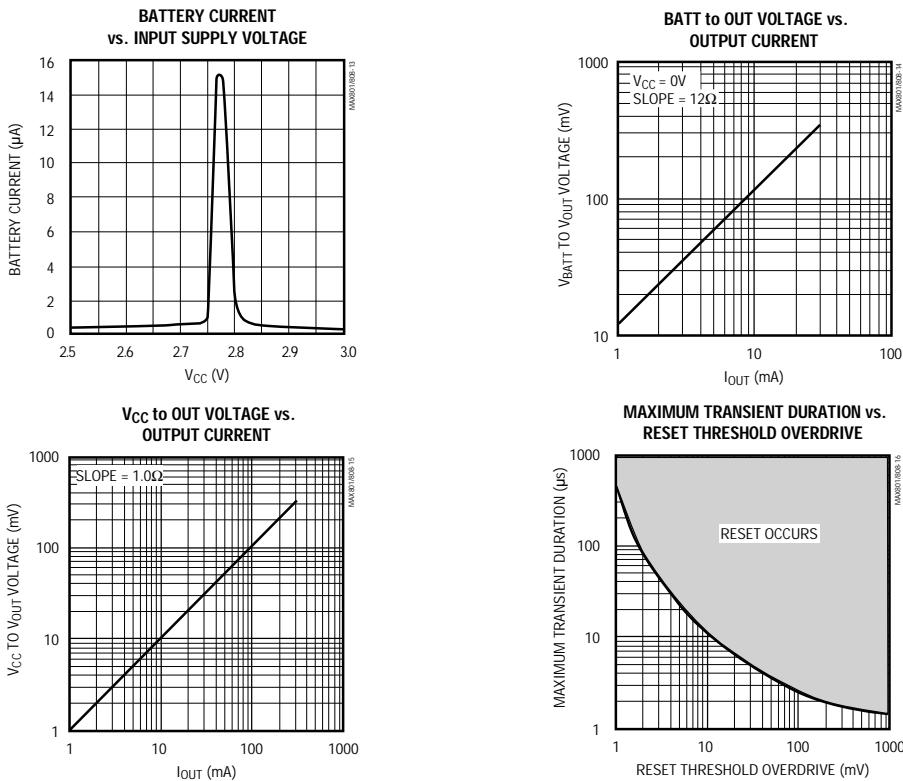
($V_{CC} = 5V$, $V_{BATT} = 2.8V$, no load, $T_A = +25^\circ C$, unless otherwise noted.)



8-Pin μ P Supervisory Circuits with $\pm 1.5\%$ Reset Accuracy

Typical Operating Characteristics (continued)

($V_{CC} = 5V$, $V_{BATT} = 2.8V$, no load, $T_A = +25^\circ C$, unless otherwise noted.)



Pin Description

PIN		NAME	FUNCTION
MAX801	MAX808		
1	1	V _{CC}	Input Supply Voltage, nominally +5V. Bypass with a 0.1µF capacitor to GND.
2	2	LOWLINE	Low-Line Comparator Output. This CMOS-logic output goes low when V _{CC} falls to 52mV above the reset threshold. Use LOWLINE to generate an NMI, initiating an orderly shutdown routine when V _{CC} is falling. LOWLINE swings between V _{CC} and GND.
3	3	RESET	Active-Low Reset Output. RESET is triggered and stays low when V _{CC} is below the reset threshold (or during a watchdog timeout for the MAX801). It remains low 200ms after V _{CC} rises above the reset threshold (or 200ms after the watchdog timeout occurs). RESET has a strong pull-down but a relatively weak pull-up, and can be wire-OR connected to logic gates. Valid for V _{CC} \geq 1V. RESET swings between V _{CC} and GND.
4	4	GND	Ground

8-Pin μ P Supervisory Circuits with $\pm 1.5\%$ Reset Accuracy

Pin Description (continued)

PIN		NAME	FUNCTION
MAX801	MAX808		
5	—	RESET	Active-High Reset Output. RESET is the inverse of $\overline{\text{RESET}}$. It is a CMOS output that sources and sinks current. RESET swings between V _{CC} and GND.
—	5	$\overline{\text{CE}}$ OUT	Chip-Enable Output. Output to the chip-enable gating circuit. $\overline{\text{CE}}$ OUT is pulled up to the higher of V _{CC} or V _{BATT} when the chip-enable gate is disabled.
6	—	WDI	Watchdog Input. If WDI remains high or low longer than the watchdog timeout period (typically 1.6sec), $\overline{\text{RESET}}$ will be asserted for 200ms. Leave unconnected to disable the watchdog function.
—	6	$\overline{\text{CE}}$ IN	Chip-Enable Input
7	7	BATT	Backup-Battery Input. When V _{CC} falls below the reset threshold and V _{BATT} , OUT switches from V _{CC} to BATT. V _{BATT} may exceed V _{CC} . The battery can be removed while the MAX801/MAX808 is powered up, provided BATT is bypassed with a 0.1 μ F capacitor to GND. If no battery is used, connect BATT to ground and V _{CC} to OUT.
8	8	OUT	Output Supply Voltage to CMOS RAM. When V _{CC} exceeds the reset threshold or V _{BATT} , OUT connects to V _{CC} . When V _{CC} falls below the reset threshold and V _{BATT} , OUT connects to BATT. Bypass OUT with a 0.1 μ F capacitor to GND.

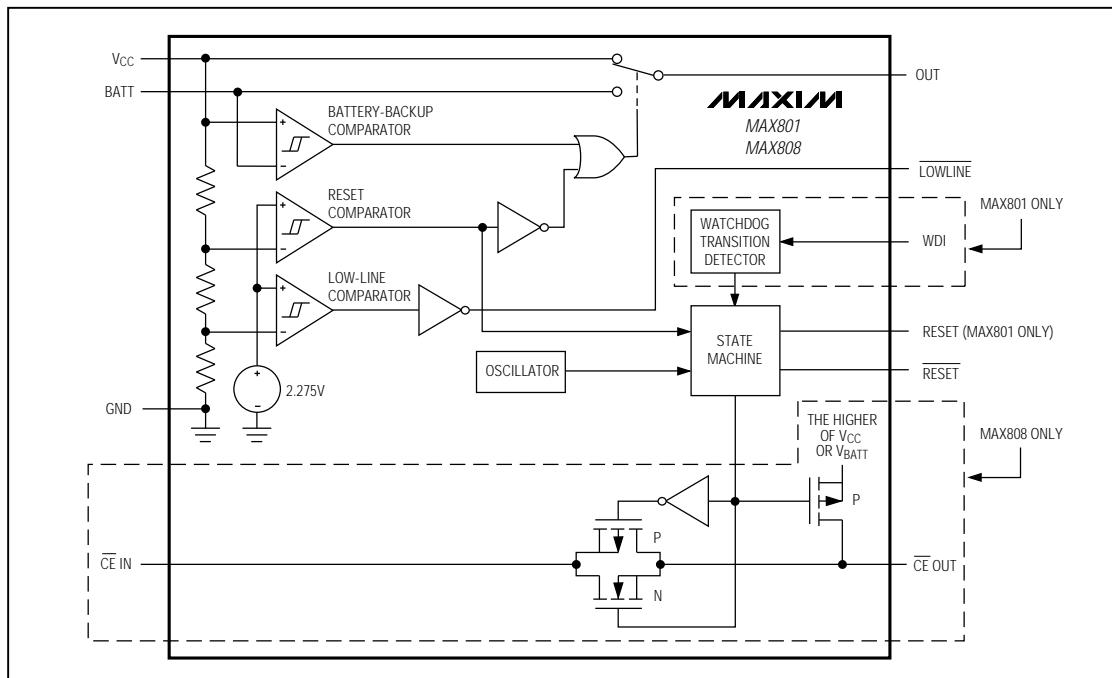


Figure 1. Functional Diagram

8-Pin μ P Supervisory Circuits with $\pm 1.5\%$ Reset Accuracy

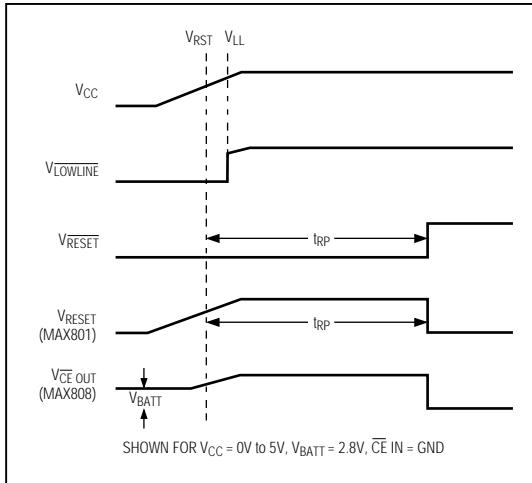


Figure 2a. Timing Diagram, V_{CC} Rising

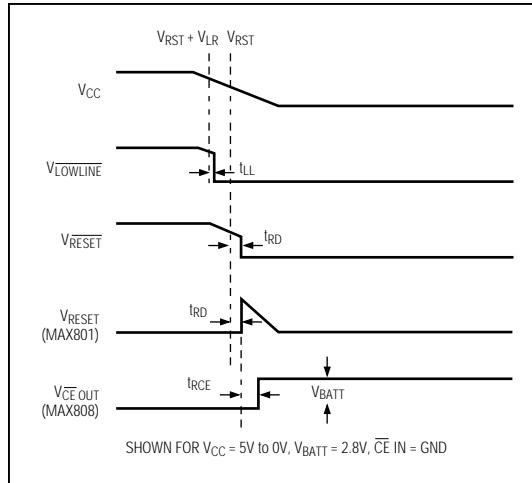


Figure 2b. Timing Diagram, V_{CC} Falling

Detailed Description

The MAX801/MAX808 microprocessor (μ P) supervisory circuits provide power-supply monitoring and backup-battery switchover in μ P systems. The MAX801 also provides program-execution watchdog functions (Figure 1). Use of BiCMOS technology results in an improved, 1.5% reset-threshold precision while keeping supply currents typically at 68 μ A (48 μ A for the MAX808). The MAX801/MAX808 are intended for battery-powered applications that require high reset-threshold precision, allowing a wide power-supply operating range while preventing the system from operating below its specified voltage range.

RESET and RESET Outputs

The MAX801/MAX808's RESET output ensures that the μ P powers up in a known state, and prevents code-execution errors during power-down and brownout conditions. It does this by resetting the μ P, terminating program execution when V_{CC} dips below the reset threshold. Each time RESET is asserted, it stays low for at least the 200ms reset timeout period (set by an internal timer) to ensure the μ P has adequate time to return to an initial state. The internal timer restarts any time V_{CC} goes below the reset threshold (V_{RST}) before the reset timeout period is completed. The watchdog timer on the MAX801 can also initiate a reset (see the MAX801 Watchdog Timer section).

The RESET output is active low, and is implemented with a strong pull-down/relatively weak pull-up structure. It is guaranteed to be a logic low for $0V < V_{CC} < V_{RST}$, provided V_{BATT} is greater than 2V. Without a backup battery, RESET is guaranteed valid for $V_{CC} \geq 1V$.

The RESET output is the inverse of the RESET output; it both sources and sinks current and cannot be wire-OR connected.

Low-Line Comparator

The low-line comparator monitors V_{CC} with a threshold voltage typically 52mV above the reset threshold, with 13mV of hysteresis. Use LOWLINE to provide a non-maskable interrupt (NMI) to the μ P when power begins to fall, initiating an orderly software shutdown routine. In most battery-operated portable systems, reserve energy in the battery provides ample time to complete the shutdown routine once the low-line warning is encountered and before reset asserts. If the system must contend with a more rapid V_{CC} fall time (such as when the main battery is disconnected, when a DC-DC converter shuts down, or when a high-side switch is opened during normal operation), use capacitance on the V_{CC} line to provide time to execute the shutdown routine (Figure 3). First calculate the worst-case time required for the system to perform its shutdown routine. Then, with worst-case shutdown time, worst-case load current, and minimum low-line to reset threshold (V_{LR(min)}),

8-Pin μ P Supervisory Circuits with $\pm 1.5\%$ Reset Accuracy

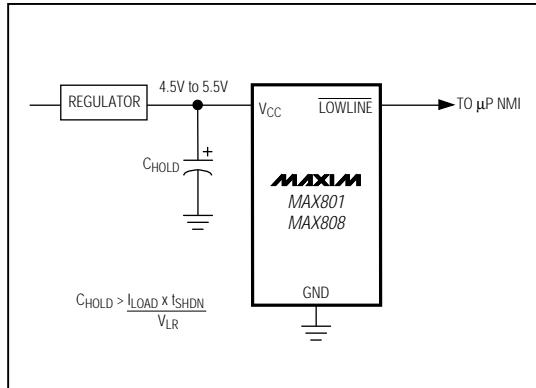


Figure 3. Using LOWLINE to Provide a Power-Fail Warning to the μ P

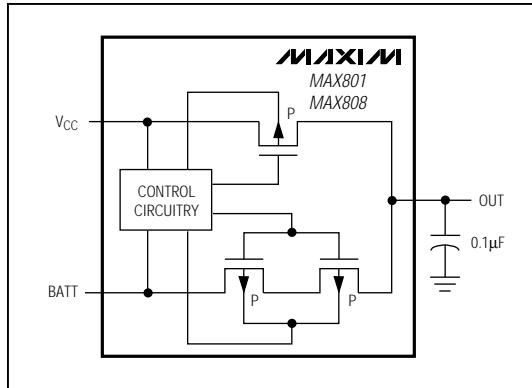


Figure 4. VCC and BATT to OUT Switch

calculate the amount of capacitance required to allow the shutdown routine to complete before reset is asserted:

$$C_{HOLD} = (I_{LOAD} \times t_{SHDN}) / (V_{LR}(\min))$$

where t_{SHDN} is the time required for the system to complete the shutdown routine (including the Vcc to low-line propagation delay), I_{LOAD} is the current being drained from the capacitor, and V_{LR} is the low-line to reset threshold.

Output Supply Voltage

The output supply (OUT) transfers power from VCC or BATT to the μ P, RAM, and other external circuitry. At the maximum source current of 250mA, V_{OUT} will typically be 220mV below Vcc. Decouple OUT with a 0.1μ F capacitor to ground.

Battery-Backup Mode

Battery-backup mode preserves the contents of RAM in the event of a brownout or power failure. With a backup battery installed at BATT, the MAX801/MAX808 automatically switches RAM to backup power when VCC falls. Two conditions are required for switchover to battery-backup mode: 1) VCC must be below the reset threshold; 2) VCC must be below V_{BATT} . Table 1 lists the status of inputs and outputs during battery-backup mode.

BATT is designed to conduct up to 20mA to OUT during battery backup. The PMOS switch on-resistance is approximately 12Ω . Figure 4 shows the two series pass elements (between the BATT input and OUT) that facilitate UL recognition. V_{BATT} can exceed Vcc during normal operation without causing a reset.

Table 1. Input and Output Status in Battery-Backup Mode

PIN		NAME	STATUS
MAX801	MAX808		
1	1	Vcc	Battery switchover comparator monitors Vcc for active switchover.
2	2	LOWLINE	Logic low
3	3	RESET	Logic low
4	4	GND	Ground—0V reference for all signals
5	—	RESET	Logic high; the open-circuit voltage is equal to Vcc.
—	5	\overline{CE} OUT	Logic high. The open-circuit output voltage is equal to V_{BATT} (MAX808).
6	—	WDI	WDI is ignored and goes high impedance.
—	6	\overline{CE} IN	High impedance (MAX808)
7	7	BATT	Supply current is 1 μ A max for $V_{BATT} \leq 2.8V$.
8	8	OUT	OUT is connected to BATT through two internal PMOS switches in series.

8-Pin μ P Supervisory Circuits with $\pm 1.5\%$ Reset Accuracy

MAX801 Watchdog Timer

The watchdog monitors the μ P's activity. If the μ P does not toggle the watchdog input (WDI) within 1.6sec, reset asserts for the reset timeout period. The internal 1.6sec timer is cleared when reset asserts or when a transition (low-to-high or high-to-low) occurs at WDI while reset is not asserted. The timer remains cleared and does not count as long as reset is asserted. It starts counting as soon as reset is released (Figure 5). Supply current is typically reduced by 10 μ A when WDI is at a valid logic level. To disable the watchdog function, leave WDI unconnected. An internal voltage divider sets WDI to about mid-supply, disabling the watchdog timer/counter.

MAX808 Chip-Enable Gating

The MAX808 provides internal gating of chip-enable (CE) signals to prevent erroneous data from corrupting CMOS RAM in the event of a power failure. During normal operation, the CE gate is enabled and passes all CE transitions. When reset is asserted, this path becomes disabled, preventing erroneous data from corrupting the CMOS RAM. The MAX808 uses a series transmission gate from the chip-enable input (\overline{CE} IN) to the chip-enable output (\overline{CE} OUT) (Figure 1). The 8ns max chip-enable propagation from \overline{CE} IN to \overline{CE} OUT enables the MAX808 to be used with most μ Ps.

The MAX808 also features write-cycle-completion circuitry. If V_{CC} falls below the reset threshold while the μ P is writing to RAM, the MAX808 holds the CE gate enabled for 18 μ s to allow the μ P to complete the write instruction. If the write cycle has not completed by the end of the 18 μ s period, the CE transmission gate turns off and \overline{CE} OUT goes high. If the μ P completes the write instruction during the 18 μ s period, the CE gate turns off (high impedance) and \overline{CE} OUT goes high as soon as the μ P pulls \overline{CE} IN high. \overline{CE} OUT remains high, even if \overline{CE} IN falls low for any reason (Figure 6).

Chip-Enable Input

\overline{CE} IN is high impedance (disabled mode) while reset is asserted. During a power-down sequence when V_{CC} passes the reset threshold, the CE transmission gate disables. \overline{CE} IN becomes high impedance 18 μ s after reset asserts, provided \overline{CE} IN is still low. If the μ P completes the write instruction during the 18 μ s period, the CE gate turns off. \overline{CE} IN becomes high impedance as soon as the μ P pulls \overline{CE} IN high. \overline{CE} IN remains high impedance even if the signal at \overline{CE} IN falls low (Figure 6). During a power-up sequence, \overline{CE} IN remains high impedance (regardless of \overline{CE} IN activity) until reset is deasserted following the reset timeout period.

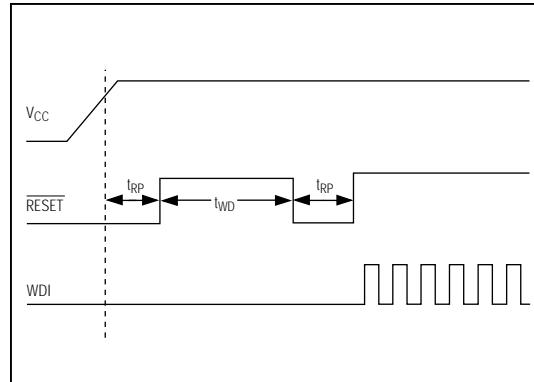


Figure 5. Watchdog Timing

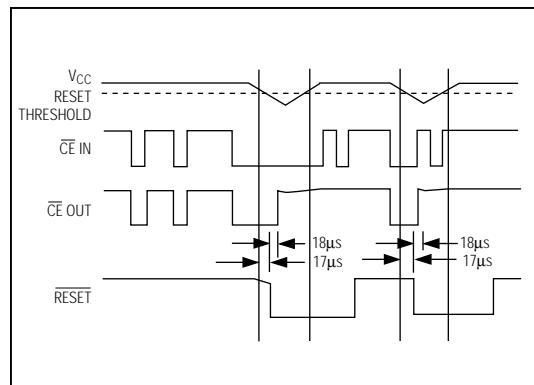


Figure 6. Chip-Enable Timing

In high-impedance mode, the leakage currents into this input are $\pm 1\mu$ A max over temperature. In low-impedance mode, the impedance of \overline{CE} IN appears as a 75 Ω resistor in series with the load at \overline{CE} OUT.

The propagation delay through the CE transmission gate depends on both the source impedance of the drive to \overline{CE} IN and the capacitive loading on \overline{CE} OUT (see the Chip-Enable Propagation Delay vs. \overline{CE} OUT Load Capacitance graph in the *Typical Operating Characteristics*). The CE propagation delay is production tested from the 50% point on \overline{CE} IN to the 50% point on \overline{CE} OUT using a 50 Ω driver and 50pF of load capacitance (Figure 7). For minimum propagation delay, minimize the capacitive load at \overline{CE} OUT and use a low-output-impedance driver.

8-Pin μ P Supervisory Circuits with $\pm 1.5\%$ Reset Accuracy

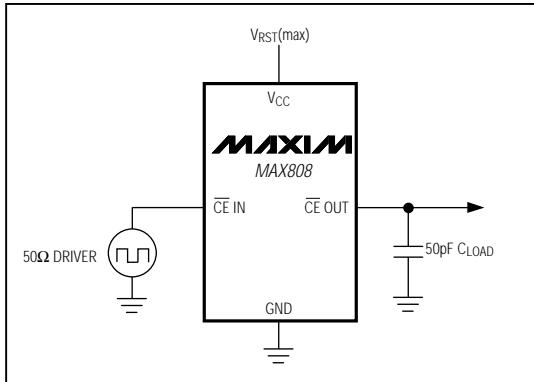


Figure 7. MAX808 CE Gate Test Circuit

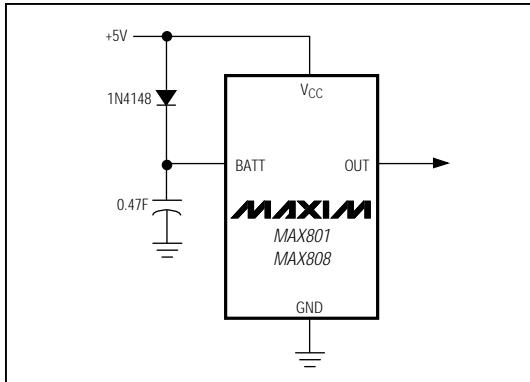


Figure 8. Using the MAX801/MAX808 with a SuperCap

Chip-Enable Output

In enabled mode, $\overline{\text{CE}}$ OUT's impedance is equivalent to 75Ω in series with the source driving $\overline{\text{CE}}$ IN. In disabled mode, the 75Ω transmission gate is off and $\overline{\text{CE}}$ OUT is actively pulled to the higher of VCC or VBATT . The source turns off when the transmission gate is enabled.

Applications Information

The MAX801/MAX808 are not short-circuit protected. Shorting OUT to ground, other than power-up transients such as charging a decoupling capacitor, may destroy the device. If long leads connect to the IC's inputs, ensure that these lines are free from ringing and other conditions that would forward bias the IC's protection diodes. Bypass OUT, Vcc, and BATT with $0.1\mu\text{F}$ capacitors to GND.

The MAX801/MAX808 operate in two distinct modes:

- 1) Normal Operating Mode, with all circuitry powered up. Typical supply current from Vcc is $68\mu\text{A}$ ($48\mu\text{A}$ for the MAX808), while only leakage currents flow from the battery.
- 2) Battery-Backup Mode, where Vcc is below VBATT and VRST. The supply current from the battery is typically less than $1\mu\text{A}$.

Using SuperCaps™ or MaxCaps™ with the MAX801/MAX808

BATT has the same operating voltage range as Vcc, and the battery-switchover threshold voltage is typically VBATT when Vcc is decreasing or $\text{VBATT} + 0.05\text{V}$ when Vcc is increasing. This hysteresis allows use of a SuperCap (e.g., around 0.47F) and a simple charging

circuit as a backup source (Figure 8). Since VBATT can exceed Vcc while Vcc is above the reset threshold, no special precautions are needed when using these μ P supervisors with a SuperCap.

Backup-Battery Replacement

The backup battery can be disconnected while Vcc is above the reset threshold, provided BATT is bypassed with a $0.1\mu\text{F}$ capacitor to ground. No precautions are necessary to avoid spurious reset pulses.

Negative-Going Vcc Transients

While issuing resets to the μ P during power-up, power-down, and brownout conditions, these supervisors are relatively immune to short-duration, negative-going Vcc transients (glitches). It is usually undesirable to reset the μ P when Vcc experiences only small glitches.

The *Typical Operating Characteristics* show a graph of Maximum Transient Duration vs. Reset Threshold Overdrive, for which reset pulses are not generated. The graph was produced using negative-going Vcc pulses, starting at 5V and ending below the reset threshold by the magnitude indicated (reset comparator overdrive). The graph shows the maximum pulse width that a negative-going Vcc transient may typically have without causing a reset pulse to be issued. As the amplitude of the transient increases (i.e., goes farther below the reset threshold), the maximum allowable pulse width decreases. Typically, a Vcc transient that goes 40mV below the reset threshold and lasts for $3\mu\text{s}$ or less will not cause a reset pulse to be issued. A $0.1\mu\text{F}$ bypass capacitor mounted close to the Vcc pin provides additional transient immunity.

8-Pin μ P Supervisory Circuits with $\pm 1.5\%$ Reset Accuracy

Watchdog Software Considerations

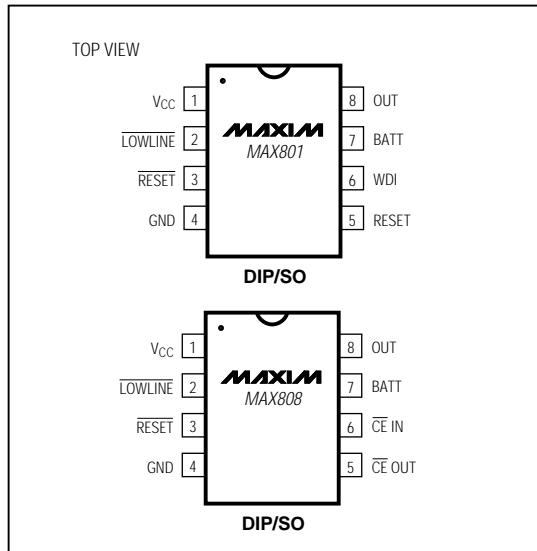
To help the watchdog timer keep a closer watch on software execution, you can set and reset the watchdog input at different points in the program, rather than "pulsing" the watchdog input high-low-high or low-high-low. This technique avoids a "stuck" loop, where the watchdog timer continues to be reset within the loop, keeping the watchdog from timing out.

Figure 9 shows a sample flow diagram where the I/O driving the watchdog input is set high at the beginning of the program, low at the beginning of every subroutine or loop, then high again when the program returns to the beginning. If the program should "hang" in any subroutine, the I/O would be continually set low and the watchdog timer would be allowed to time out, causing a reset or interrupt to be issued.

Maximum V_{CC} Fall Time

The V_{CC} fall time is limited by the propagation delay of the battery switchover comparator and should not exceed $0.03V/\mu s$. A standard rule for filter capacitance on most regulators is around $100\mu F$ per Ampere of current. When the power supply is shut off or the main battery is disconnected, the associated initial V_{CC} fall rate is just the inverse, or $1A/100\mu F = 0.01V/\mu s$.

Pin Configurations



Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

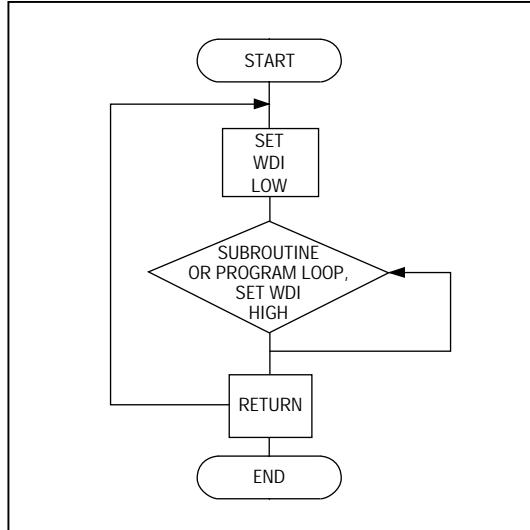


Figure 9. Watchdog Flow Diagram

Chip Information

TRANSISTOR COUNT: 922